

#### N-Channel Enhancement Mode MOSFET

#### **Features**

- 60V/190A  $R_{DS(ON)} = 3.2 \text{ m}\Omega \text{ (typ.) } @ V_{GS} = 10V$
- 100% avalanche tested
- Reliable and Rugged
- Lead Free and Green Devices Available (RoHS Compliant)

### **Pin Description**



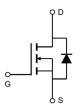


TO-220FB-3L

TO-263-2L

## **Applications**

- Switching application
- Power Management for Inverter Systems.



N-Channel MOSFET

# Ordering and Marking Information





Package Code

P: TO-220FB-3L

B: TO-263-2L

Date Code YYXXX WW Assembly Material G: Lead Free Device

Note: HUAYI lead -free products contain molding compounds/die attach materials and 100% matte tin plate Termination finish; which are fully compliant with RoHS. HUAYI lead -free products meet or exceed the lead-free requirements of IPC/JEDEC J-STD-020 for MSL classification at lead-free peak reflow temperature. HUAYI defines "Green" to mean lead-free (RoHS compliant) and halogen free (Br or CI does not exceed 900ppm by weight in homogeneous material and total of Br and CI does not exceed 1500ppm by weight).

HUAYI reserves the right to make changes, corrections, enhancements, modifications, and improvements to this pr-oduct and/or to this document at any time without notice.



# **Absolute Maximum Ratings**

Symbol	Parameter		Rating	Unit		
Common	Common Ratings (T <sub>c</sub> =25°C Unless Otherwise Noted)					
V <sub>DSS</sub>	Drain-Source Voltage		60			
V <sub>GSS</sub>	Gate-Source Voltage		±25			
TJ	Maximum Junction Temperature		175	°C		
T <sub>STG</sub>	Storage Temperature Range		-55 to 175	°C		
Is	Diode Continuous Forward Current	T <sub>C</sub> =25°C	190	А		
Mounted	on Large Heat Sink		•			
I <sub>DM</sub>	Pulsed Drain Current *	T <sub>C</sub> =25°C	720**	А		
	Continuous Proin Current	T <sub>C</sub> =25°C	190	А		
l <sub>D</sub>	Continuous Drain Current	T <sub>C</sub> =100°C	128			
В	Maximum Bayyar Dissipation	T <sub>C</sub> =25°C	220	W		
P <sub>D</sub>	Maximum Power Dissipation	T <sub>C</sub> =100°C	110			
$R_{\theta JC}$	Thermal Resistance-Junction to Case		0.68	°C/W		
$R_{\theta JA}$	Thermal Resistance-Junction to Ambient		62.5			
Avalanche	Avalanche Ratings					
E <sub>AS</sub>	Avalanche Energy, Single Pulsed	L=0.5mH	1.3***	J		

Note: \* Repetitive rating; pulse width limited by junction temperature 
\*\* Drain current is limited by junction temperature

# **Electrical Characteristics** (T<sub>c</sub> = 25°C Unless Otherwise Noted)

Symbol	Parameter	Test Conditions	HY3906		<b>5</b>	Unit	
Syllibol	raidilleter rest Conditions		Min.	Тур.	Max.	Ollit	
Static Cha	racteristics						
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V, I <sub>DS</sub> =250μA	60	-	-	V	
	Zero Gate Voltage Drain Current	V <sub>DS</sub> =60V, V <sub>GS</sub> =0V	-	-	1	^	
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	T <sub>J</sub> =85°C	-	-	10	μΑ	
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS}=V_{GS}$ , $I_{DS}=250\mu A$	2.0	3.0	4.0	V	
I <sub>GSS</sub>	Gate Leakage Current	$V_{GS}=\pm25V, V_{DS}=0V$	-	-	±100	nA	
R <sub>DS(ON)</sub> *	Drain-Source On-state Resistance	V <sub>GS</sub> =10V, I <sub>DS</sub> =95A	-	3.2	4.0	mΩ	
Diode Cha	Diode Characteristics						
V <sub>SD</sub> *	Diode Forward Voltage	I <sub>SD</sub> =95A, V <sub>GS</sub> =0V	-	0.8	1.2	V	
t <sub>rr</sub>	Reverse Recovery Time	05 \ dl \ /dt 100 \ /	-	48	-	ns	
Q <sub>rr</sub>	Reverse Recovery Charge	I <sub>SD</sub> =95A, dl <sub>SD</sub> /dt=100A/μs	-	72	-	nC	

<sup>\*\*\*</sup> VD=48V



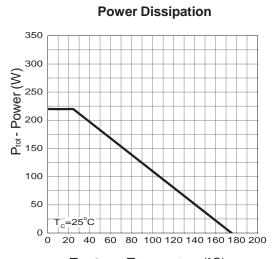
# **Electrical Characteristics (Cont.)** $(T_c = 25^{\circ}C \text{ Unless Otherwise Noted})$

Cumbal	Parameter	Test Conditions	HY3906		5	l lmi4
Symbol	Symbol Parameter rest Conditions		Min.	Тур.	Max.	Unit
Dynamic (	Characteristics					
R <sub>G</sub>	Gate Resistance	V <sub>GS</sub> =0V,V <sub>DS</sub> =0V,F=1MHz	-	1.9	-	Ω
C <sub>iss</sub>	Input Capacitance	$V_{GS}=0V$ ,	-	5726	-	
C <sub>oss</sub>	Output Capacitance	V <sub>DS</sub> =25V,	-	1014	-	pF
C <sub>rss</sub>	Reverse Transfer Capacitance	Frequency=1.0MHz	-	506	-	
t <sub>d(ON)</sub>	Turn-on Delay Time	$V_{DD}$ =30V, $R_{G}$ =6 $\Omega$ , $I_{DS}$ =95A, $V_{GS}$ =10V,	-	28	-	
Tr	Turn-on Rise Time		-	18	-	ns
t <sub>d(OFF)</sub>	Turn-off Delay Time		-	42	-	115
T <sub>f</sub>	Turn-off Fall Time		-	54	-	
Gate Charge Characteristics						
Qg	Total Gate Charge	.,,	-	135	-	
$Q_gs$	Gate-Source Charge		-	24	-	nC
$Q_{gd}$	Gate-Drain Charge	103 2311	-	49	-	

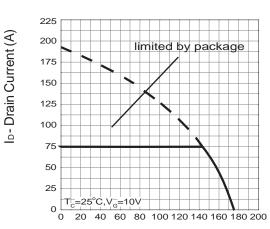
Note \* : Pulse test ; pulse width  $\leq\!300\mu s,$  duty cycle  $\leq\!2\%.$ 



# **Typical Operating Characteristics**



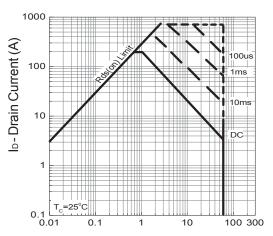
**Drain Current** 



T<sub>c</sub>- Case Temperature (°C)

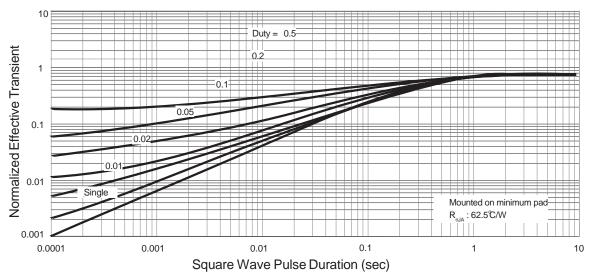
T<sub>c</sub>-Case Temperature (°C)

### **Safe Operation Area**



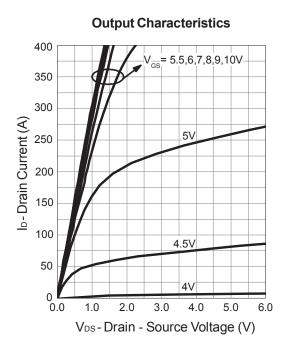
V<sub>DS</sub> - Drain - Source Voltage (V)

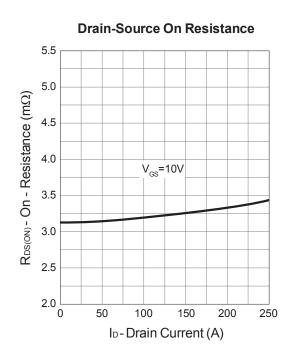
#### **Thermal Transient Impedance**

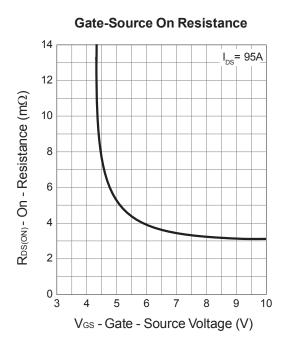


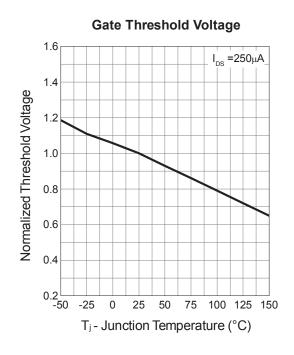


# **Typical Operating Characteristics (Cont.)**



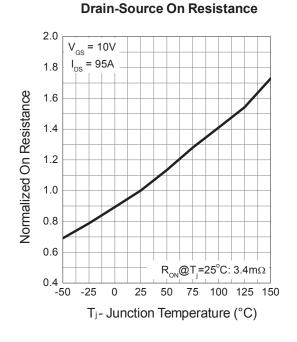




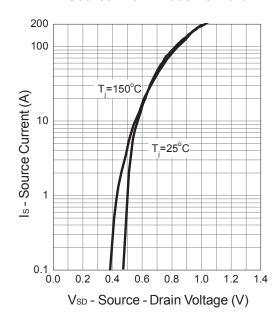




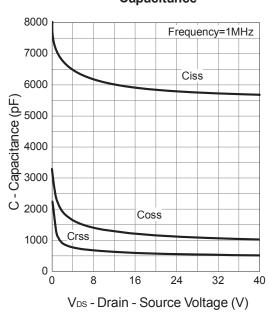
# **Typical Operating Characteristics (Cont.)**



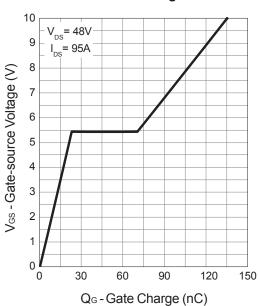
#### Source-Drain Diode Forward



### Capacitance

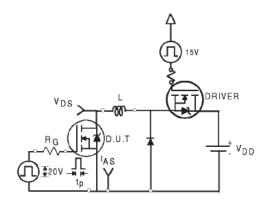


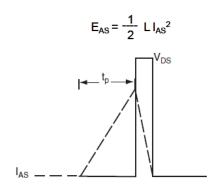
#### **Gate Charge**



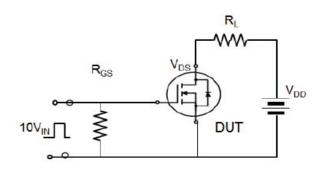


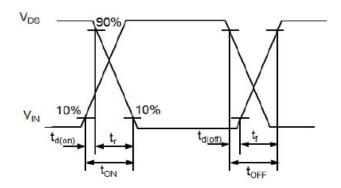
### **Avalanche Test Circuit**



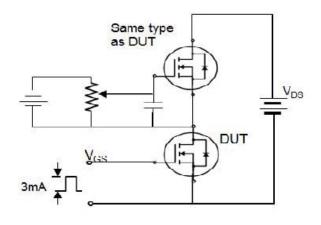


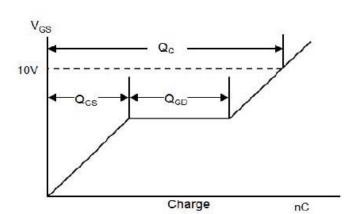
# **Switching Time Test Circuit**





# **Gate Charge Test Circuit**





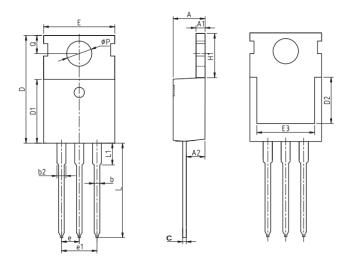


# **Device Per Unit**

Package Type	Unit	Quantity
TO-220FB-3L	Tube	50

# **Package Information**

### TO-220FB-3L



#### **COMMON DIMENSIONS**

SYMBOL		mm	
STIVIDOL	MIN	NOM	MAX
А	4.37	4.57	4.77
A1	1.25	1.30	1.45
A2	2.20	2.40	2.60
b	0.70	0.80	0.95
b2	1.17	1.27	1.47
С	0.40	0.50	0.65
D	15.10	15.60	16.10
D1	8.80	9.10	9.40
D2	5.50	-	-
E	9.70	10.00	10.30
E3	7.00	-	-
е		2.54 BSC	
e1		5.08 BSC	
H1	6.25	6.50	6.85
L	12.75	13.50	13.80
L1	-	3.10	3.40
ФР	3.40	3.60	3.80
Q	2.60	2.80	3.00

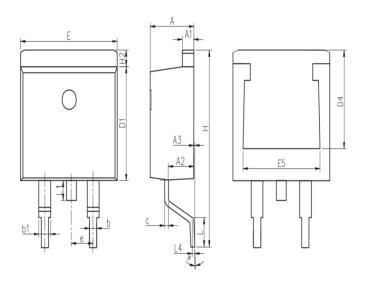


### **Device Per Unit**

Package Type	Unit	Quantity
TO-263-2L	Reel	50

# **Package Information**

### TO-263-2L

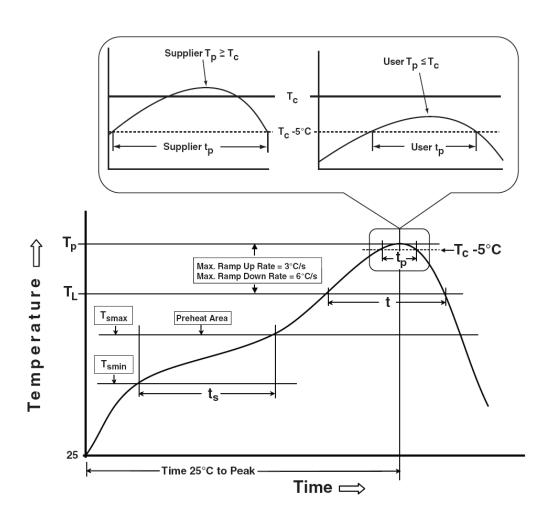


### COMMON DIMENSIONS

SYMBOL		mm	
STIVIBUL	MIN	NOM	MAX
А	4.37	4.57	4.77
A1	1.22	1.27	1.42
A2	2.49	2.69	2.89
A3	0	0.13	0.25
b	0.7	0.81	0.96
b1	1.17	1.27	1.47
С	0.3	0.38	0.53
D1	8.5	8.7	8.9
D4	6.6	-	-
Е	9.86	10.16	10.36
E5	7.06	-	-
е		2.54 BSC	;
Н	14.7	15.1	15.5
H2	1.07	1.27	1.47
L	2	2.3	2.6
L1	1.4	1.55	1.7
L4	0.25 BSC		;
θ	0°	5°	9°



### **Classification Profile**



### **Classification Reflow Profiles**

Sn-Pb Eutectic Assembly	Pb-Free Assembly
100 °C 150 °C 60-120 seconds	150 °C 200 °C 60-120 seconds
3 °C/second max.	3°C/second max.
183 °C 60-150 seconds	217 °C 60-150 seconds
See Classification Temp in table 1	See Classification Temp in table 2
20** seconds	30** seconds
6 °C/second max.	6 °C/second max.
6 minutes max.	8 minutes max.
	100 °C 150 °C 60-120 seconds  3 °C/second max.  183 °C 60-150 seconds  See Classification Temp in table 1  20** seconds  6 °C/second max.

Tolerance for peak profile Temperature  $(T_p)$  is defined as a supplier minimum and a user maximum. Tolerance for time at peak profile temperature  $(t_p)$  is defined as a supplier minimum and a user maximum.

### HY3906P/B



Table 1. SnPb Eutectic Process – Classification Temperatures (Tc)

Package Thickness	Volume mm <sup>3</sup> <350	Volume mm³ ≥350
<2.5 mm	235 °C	220 °C
≥2.5 mm	220 °C	220 °C

Table 2. Pb-free Process - Classification Temperatures (Tc)

Package Thickness	Volume mm <sup>3</sup> <350	Volume mm <sup>3</sup> 350-2000	Volume mm <sup>3</sup> >2000
<1.6 mm	260 °C	260 °C	260 °C
1.6 mm – 2.5 mm	260 °C	250 °C	245 °C
≥2.5 mm	250 °C	245 °C	245 °C

# **Reliability Test Program**

Test item	Method	Description
SOLDERABILITY	JESD-22, B102	5 Sec, 245°C
HTRB	JESD-22, A108	168 Hrs /500 Hrs /1000 Hrs, Bias @ 150°C
PCT	JESD-22, A102	96Hrs, 100%RH, 2atm, 121°C
TCT	JESD-22, A104	500 Cycles, -55°C~150°C

#### **Customer Service**

Worldwide Sales and Service: sales@hymexa.com Technical Support: Technology@hymexa.com Xi'an Huayi Microelectronics Co., Ltd.

No.8928, Shangji Road, Economic and Technological Development Zone, Xi'an, China

TEL: (86-029) 86685706 FAX: (86-029) 86685705 E-mail: sales@hymexa.com Web net: www.hymexa.com